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**Disclaimer:** This document is still far from complete.

## Symbolic To Real Conversion in Alliance

### Contents

<b>Symbolic To Real Conversion in Alliance</b> . . . . .	<b>1</b>
Symbolic Layout . . . . .	<b>2</b>
Symbolic Components . . . . .	<b>2</b>
Symbolic Segments . . . . .	<b>3</b>
The RDS File . . . . .	<b>4</b>
Physical Grid & Lambda Value . . . . .	<b>4</b>
The MBK_TO_RDS_SEGMENT table . . . . .	<b>4</b>
The MBK_TO_RDS_VIA table . . . . .	<b>7</b>
The MBK_TO_RDS_BIGVIA_HOLE table . . . . .	<b>7</b>
The MBK_TO_RDS_BIGVIA_METAL table . . . . .	<b>8</b>
The MBK_WIRESETTING table . . . . .	<b>9</b>

## Symbolic Layout

### Symbolic Components

A symbolic layout is, in practice, made of only of three objects:

Object	MBK	Explanation
Segments	phseg	Oriented segments with a width and an orientation.
VIAs & contacts	phvia	Boils down to just a point.
Big VIAs & Big Contacts	phvia	Point with a width and a height That is a rectangle of width by height centered on the VIA coordinates.

Each of those objects is associated to a *symbolic layer* which will control how the object is translated in many *real rectangles*.

MBK	Layer Name	Usable By	Usage
phseg	NWELL	Segment	N Well
	PWELL	Segment	P Well
	NDIF	Segment	N Diffusion
	PDIF	Segment	P Diffusion
	NTIE	Segment	N Tie
	PTIE	Segment	P Tie
	NTRANS	Segment	N transistor, in ALLIANCE, a transistor is represented as a segment (it's grid).
	PTRANS	Segment	P transistor
	POLY	Segment	Polysilicium
	ALU <sub>x</sub>	Segment	Metal level $x$
	CALU <sub>x</sub>	Segment	Metal level $x$ , that can be used by the upper hierarchical level as a connector. From the layout point of view it is the same as ALU <sub>x</sub> .
TALU <sub>x</sub>	Segment	Blockage for metal level $x$ . Will disappear in the real layout as it is an information for the P&R tools only.	
phvia	CONT_BODY_N	VIA, BIGVIA	Contact to N Well
	CONT_BODY_P	VIA, BIGVIA	Contact to P Well
	CONT_DIF_N	VIA, BIGVIA	Contact to N Diffusion
	CONT_DIF_P	VIA, BIGVIA	Contact to P Diffusion
	CONT_POLY	VIA, BIGVIA	Contact to polysilicium
	CONT_VIA	VIA, BIGVIA	Contact between metal <sub>1</sub> and metal <sub>2</sub>
	CONT_VIA <sub>x</sub>	VIA, BIGVIA	Contact between metal $x$ and metal $x+1$ . The index is the the one of the bottom metal of the VIA.
	C_X_N	VIA	N transistor corner, to build transistor bend. Not used anymore in recent technos
	C_X_P	VIA	P transistor corner, to build transistor bend. Not used anymore in recent technos

**Note**

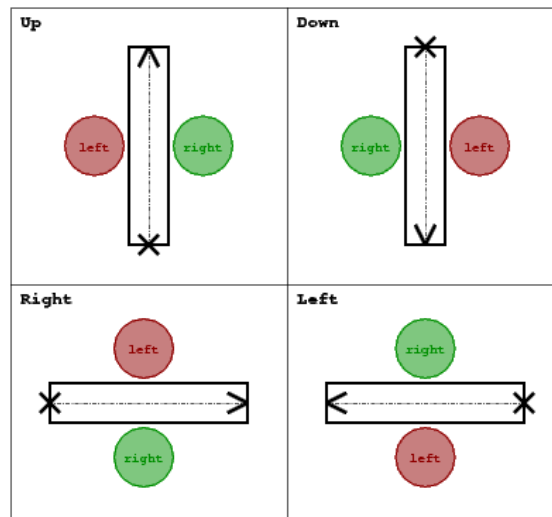
Not all association of object and symbolic layers are meaningful. For instance you cannot associate a contact to a NTRANS layer.

**Note**

The symbolic layer associated with blockages is prefixed by a T, for *transparency*, which may seems silly. It is for historical reasons, it started as a true transparency, but at some point we had to invert the meaning (blockage) with the rise of over-the-cell routing, but the name stuck...

**Symbolic Segments**

In ALLIANCE, segments are oriented (up, down, left, right). This disambiguate the left or right side when using the LCW and RCW rules in the RDS file. It allows to generate, if needed, asymmetric object in the real layout file.



## The RDS File

The RDS file control how a symbolic layout is transformed into it's real conterpart.



### Note

**Unit used inside the RDS file:** all units are expressed in micrometers.

Alliance tools relying on the RDS file, and what layers are active for them:

Tool	Name	RDS Flags
Layout editor	graal	ALL
Design Rule Checker	druc	ALL, DRC
Electrical extractor	cougar	ALL, EXT
The symbolic to real layout translator	s2r	ALL

## Physical Grid & Lambda Value

RDS file:

```
DEFINE PHYSICAL_GRID 0.005
DEFINE LAMBDA 0.09
```

Tells that the physical grid (founder grid) step is  $0.005\mu\text{m}$  and the lambda has a value of  $0.09\mu\text{m}$ . That is, one lambda is 18 grid steps.

We can distinguish two kind of RDS files:

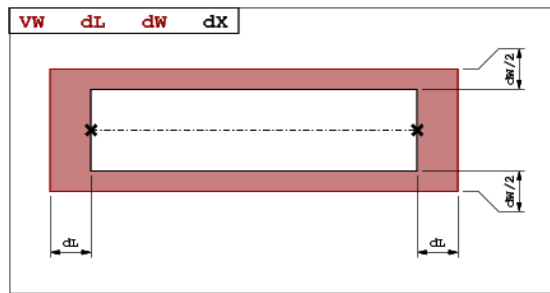
- The  $1\mu\text{m}$  kind, odd segment widths and coordinates are allowed, but the LAMBDA value **must** represent an *even* number of foundry grid step.
- The  $2\mu\text{m}$  kind, segments widths and coordinates must all be even. And in that case the LAMBDA value can be any multiple of the foundry grid.

## The MBK\_TO\_RDS\_SEGMENT table

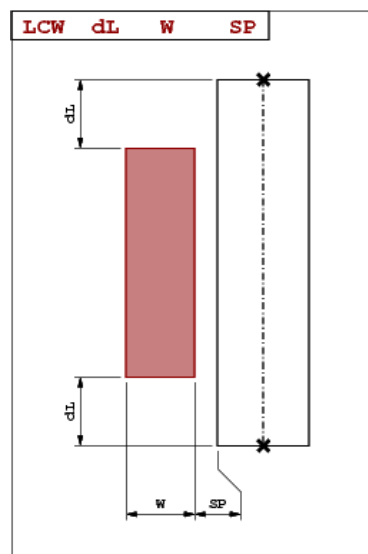
The MBK\_TO\_RDS\_SEGMENT table control the way segments are translated into real rectangles. Be aware that we are translating *segments* and not *rectangles*. Segments are defined by their axis (source & target points) and their width. The geometrical transformations are described according to that model. Obviously, they are either horizontal or vertical.

The translation method of a symbolic segment is as follow:

1. The segment is translated into one or more physical rectangles. The generated rectangles depends on the tool which is actually using RDS and the flag for the considered real layer. For instance, real layers flagged with DRC will be generated for s2r (for the cif or gds) and druc, but will not be shown under graal.
2. Translation into one real layer. *First* the source & target coordinates and width of the symbolic segment are multiplied by the LAMBDA value to obtain a real segment. *Then* one of the VW, LCW or RCW transformation is applied to that segment to get the final real rectangle.
  - VW for Variable Width, expand the real layer staying centered from the original one. In those rules, the third number is not used, it is only here to make the life easier for the parser...



- LCW or RCW for Left/Right Constant Width, create an off-center rectangle of fixed width relative to the real segment. Note that the  $SP$  number is the distance *between the edge* of the real segment and the edge of the generated real rectangle (*not from the axis*). It is often zero.



## Examples:

TABLE MBK\_TO\_RDS\_SEGMENT

# (Case 1)							
ALU1	RDS_ALU1	VW	0.18	0.09	0.0	ALL	\
# (Case 2)							
NDIF	RDS_NDIF	VW	0.18	0.0	0.0	ALL	\
	RDS_ACTIV	VW	0.18	0.0	0.0	DRC	\
	RDS_NIMP	VW	0.36	0.36	0.0	DRC	
# (Case 3)							
NTRANS	RDS_POLY	VW	0.27	0.00	0.0	ALL	\
	RDS_GATE	VW	0.27	0.00	0.0	DRC	\
	RDS_NDIF	LCW	0.0	0.27	0.0	EXT	\
	RDS_NDIF	RCW	0.0	0.27	0.0	EXT	\
	RDS_NDIF	VW	0.0	0.72	0.0	DRC	\
	RDS_ACTIV	VW	0.0	0.72	0.0	ALL	\
	RDS_NIMP	VW	0.18	1.26	0.0	DRC	

END

**Case 1** the ALU1 is translated in exactly one real rectangle of RDS\_ALU1, both ends are extended by 0.18µm and it's width is increased by 0.09µm.

**Case 2** the NDIF will be translated into only one segment under `graal`, for symbolic visualization. And into three real rectangles for `s2r` and `drc`.

**Case 3** the NTRANS, associated to a transistor is a little bit more complex, the generated shapes are different for the extractor `cougar` in one hand, and for both `drc` & `s2r` in the other hand.

- For the extractor (EXT & ALL flags) there will be four rectangles generated:
  1. The gate (RDS\_GATE)
  2. The left diffusion of the transistor (source or drain) (RDS\_NDIF).
  3. The right diffusion of the transistor (drain or source) (RDS\_NDIF).
  4. The active area (RDS\_ACTIV).

As the extractor must kept separate the source and the drain of the transistor, they are generated as two offset rectangles, using the `LCW` and `RCW` directives.

- For `s2r` and `drc` (DRC and ALL), five rectangles are generated:
  1. The poly (RDS\_POLY).
  2. The gate (RDS\_GATE).
  3. The diffusion, as one rectangle that covers both the `LCW` and the `RCW` (RDS\_NDIF).
  4. The active area (RDS\_ACTIV).
  5. The N implantation (RDS\_NIMP).

In the layout send to the foundry, the source & drain are draw as one rectangle across the gate area (the transistor being defined by the intersection of both rectangles).

### The MBK\_TO\_RDS\_VIA table

This table is to translate *default* VIAs into real via. In the symbolic layout the default VIA is simply a point and a set of layers. All layers are converted in squares shapes centered on the VIA coordinate. The one dimension given is the size of the side of that square.

Note that although we are referring to VIAs, which for the purists are between two metal layers, this table also describe *contacts*.

Example:

```
TABLE MBK_TO_RDS_VIA

CONT_DIF_P  RDS_PDIF  0.54  ALL  \
             RDS_CONT  0.18  ALL  \
             RDS_ALU1  0.36  ALL  \
             RDS_ACTIV 0.54  DRC  \
             RDS_PIMP  0.90  DRC

CONT_POLY   RDS_POLY  0.54  ALL  \
             RDS_CONT  0.18  ALL  \
             RDS_ALU1  0.36  ALL

CONT_VIA    RDS_ALU1  0.45  ALL  \
             RDS_VIA1  0.27  ALL  \
             RDS_ALU2  0.45  ALL
```

END



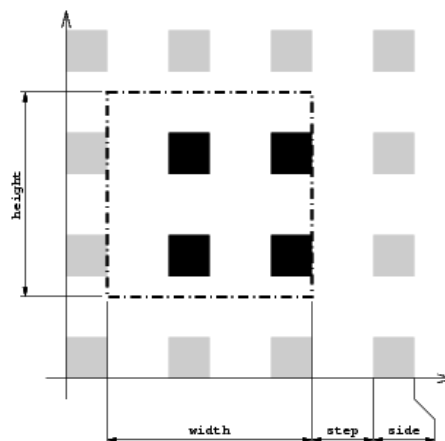
#### Note

In **CONT\_DIF\_P** you may see that only three layers will be shown under `graal`, but five will be generated in the `gds` layout.

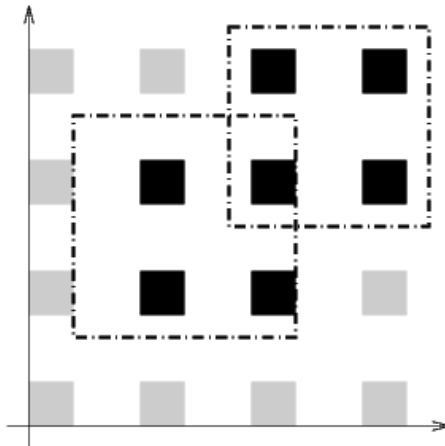
### The MBK\_TO\_RDS\_BIGVIA\_HOLE table

In `s2r`, when generating BIGVIAs, the matrix of holes they contains is not draw relative to the position of the BIGVIA itself, but on a grid which is common throughtout all the design real layout. This is to allow overlap between two BIGVIA without risking the holes matrix to be not exactly overlapping. As a consequence, when visualizing the `gds` file, the holes may not be centerend inside one individual BIGVIA.

The `MBK_TO_RDS_BIGVIA_HOLE` table define the global hole matrix for the whole design. The first number is the individual hole side and the second the grid step (edge to edge). The figure below show the hole generation.



Example of BIGVIA overlap:



Example:

```
TABLE MBK_TO_RDS_BIGVIA_HOLE
```

```
CONT_VIA   RDS_VIA1  0.27 0.27  ALL
CONT_VIA2  RDS_VIA2  0.27 0.27  ALL
CONT_VIA3  RDS_VIA3  0.27 0.27  ALL
CONT_VIA4  RDS_VIA4  0.27 0.27  ALL
CONT_VIA5  RDS_VIA5  0.36 0.36  ALL
```

END



#### Note

**BIGVIA demotion.** If the size of the bigvia is too small, there is a possibility that no hole from the global matrix will be under it. To avoid that case, if the either side of the BIGVIA is less than  $1.5 * step$ , the BIGVIA is demoted to a simple VIA.

#### The MBK\_TO\_RDS\_BIGVIA\_METAL table

This table describe how the metal part of a BIGVIA is expanded (for the hole part, see the previous table MBK\_TO\_RDS\_BIGVIA\_HOLE). The rule give for each metal:

1. The *delta-with* (have to ask Franck).
2. The *overhang*, the length the real rectangle is expanded on each side from the symbolic rectangle.

Example:

```
TABLE MBK_TO_RDS_BIGVIA_METAL
```

```
CONT_VIA   RDS_ALU1  0.0 0.09  ALL \
           RDS_ALU2  0.0 0.09  ALL

CONT_VIA2  RDS_ALU2  0.0 0.09  ALL \
           RDS_ALU3  0.0 0.09  ALL

CONT_VIA3  RDS_ALU3  0.0 0.09  ALL \
           RDS_ALU4  0.0 0.09  ALL

CONT_VIA4  RDS_ALU4  0.0 0.09  ALL \
           RDS_ALU5  0.0 0.09  ALL
```



```
CONT_VIA5 RDS_ALU5 0.0 0.09 ALL \  
          RDS_ALU6 0.0 0.18 ALL  
END
```

### The MBK\_WIRESETTING table

From a strict standpoint this table shouldn't be here but put in a separate configuration file, because it contains informations only used by the symbolic layout tools (*ocp*, *nero*, *ring*).

This table defines the cell gauge the routing pitch and minimal (symbolic) wire width and minimal spacing for the routers. They are patly redundant.

Example:

```
TABLE MBK_WIRESETTING  
  
X_GRID          10  
Y_GRID          10  
Y_SLICE         100  
WIDTH_VDD       12  
WIDTH_VSS       12  
TRACK_WIDTH_ALU8 0  
TRACK_WIDTH_ALU7 4  
TRACK_WIDTH_ALU6 4  
TRACK_WIDTH_ALU5 4  
TRACK_WIDTH_ALU4 3  
TRACK_WIDTH_ALU3 3  
TRACK_WIDTH_ALU2 3  
TRACK_WIDTH_ALU1 3  
TRACK_SPACING_ALU8 0  
TRACK_SPACING_ALU7 4  
TRACK_SPACING_ALU6 4  
TRACK_SPACING_ALU5 4  
TRACK_SPACING_ALU4 4  
TRACK_SPACING_ALU3 4  
TRACK_SPACING_ALU2 4  
TRACK_SPACING_ALU1 3  
  
END
```